# Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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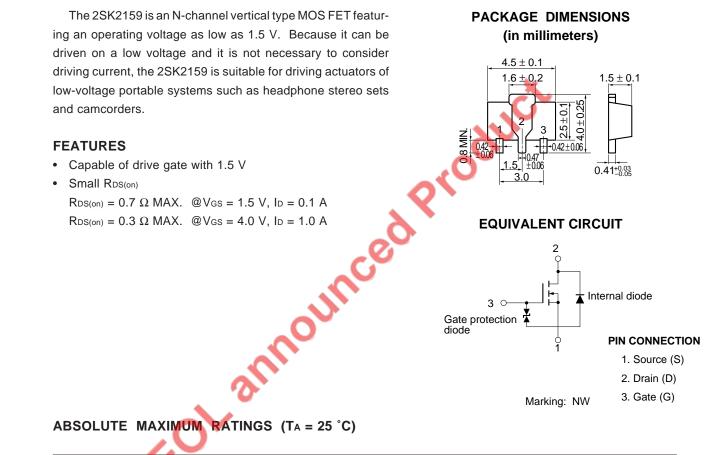
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# RENESAS

# MOS FIELD EFFECT TRANSISTOR 2SK2159

## N-CHANNEL MOS FET FOR HIGH-SPEED SWITCHING



PARAMETER	SYMBOL	TEST CONDITIONS	RATINGS	UNIT
Drain to Source Voltage	Vdss	V <sub>GS</sub> = 0	60	V
Gate to Source Voltage	Vgss	V <sub>DS</sub> = 0	±14	V
Drain Current (DC)	ID(DC)		±2.0	A
Drain Current (pulse)	D(pulse)	PW ≤ 10 ms, Duty Cycle ≤ 50 %	±4.0	A
Total Power Dissipation	P⊤	Mounted on 16 $\mbox{cm}^2 \times 0.7$ mm ceramic substrate.	2.0	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

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### ELECTRICAL CHARACTERISTICS ( $T_A = 25$ °C)

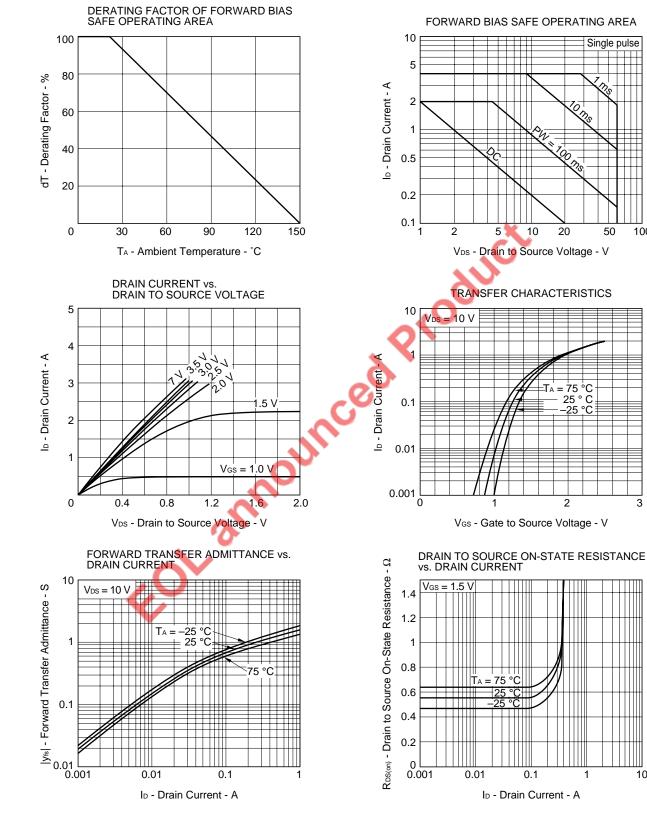
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Cut-off Current	loss	$V_{DS} = 60 V, V_{GS} = 0$			1.0	μΑ
Gate Leakage Current	lgss	$V_{GS} = \pm 14 \text{ V}, \text{ V}_{DS} = 0$			±10	μA
Gate Cut-off Voltage	VGS(off)	$V_{DS} = 10 V, I_{D} = 1 mA$	0.5	0.9	1.1	V
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1.0 A	0.4			S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 1.5 V, Id = 0.1 A		0.55	0.7	Ω
Drain to Source On-state Resistance	RDS(on)2	Vgs = 2.5 V, Id = 1.0 A		0.27	0.5	Ω
Drain to Source On-state Resistance	RDS(on)3	Vgs = 4.0 V, Id = 1.0 A		0.22	0.3	Ω
Input Capacitance	Ciss	$V_{DS} = 10 V, V_{GS} = 0,$		319		pF
Output Capacitance	Coss	f = 1.0 MHz		109		pF
Reverse Transfer Capacitance	Crss			22		pF
Turn-On Delay Time	td(on)	V <sub>DD</sub> = 25 V, I <sub>D</sub> = 1.0 A		38		ns
Rise Time	tr	$V_{GS(on)} = 3 V, R_G = 10 \Omega$		128		ns
Turn-Off Delay Time	td(off)	RL = 25 Ω	0	237		ns
Fall Time	tŕ		0	130		ns

100

3

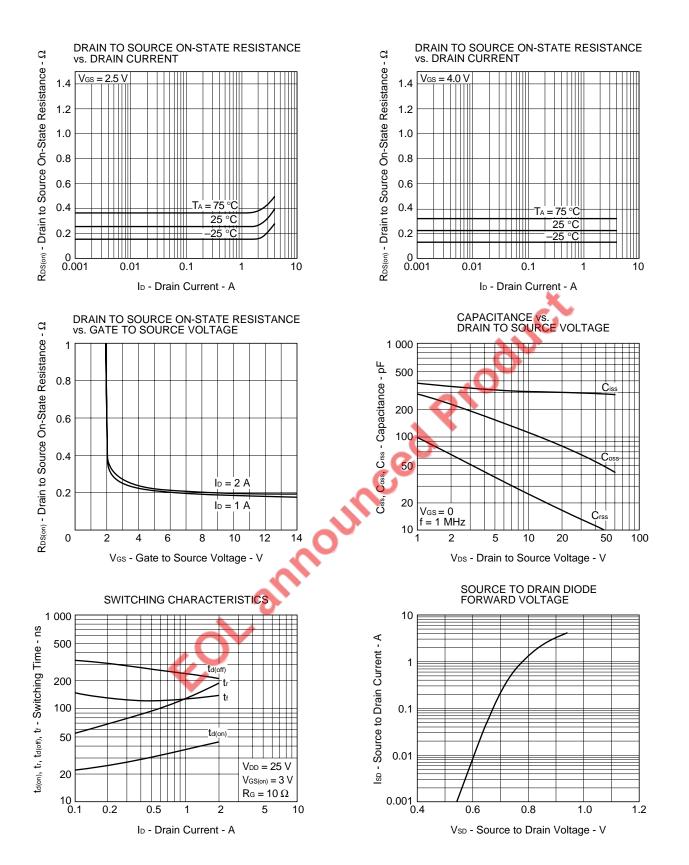
dT - Derating Factor - %

Ip - Drain Current - A



TYPICAL CHARACTERISTICS ( $T_A = 25$  °C)

10



### REFERENCE

Document Name	Document No.		
NEC semiconductor device reliability/quality control system	TEI-1202		
Quality grade on NEC semiconductor devices	IEI-1209		
Semiconductor device mounting technology manual	C10535E		
Guide to quality assurance for semiconductor devices	MEI-1202		
Semiconductor selection guide	X10679E		

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Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots

Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

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Anti-radioactive design is not implemented in this product.

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